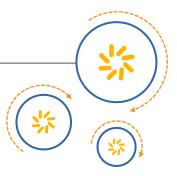


Qualcomm Technologies, Inc.



RB01

Hardware Release Notes

80-YA116-20 Rev. A July 3, 2017

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Revision history

Revision	Date	Description
Α	July 2017	Initial release

RB01 Hardware Release Notes

1 Hardware release

This document serves as the hardware release notes for RB01-010. This release includes the following hardware documentation:

- QCA4010 Low-Energy Wi-Fi Single-Band 802.11b/g/n SoC Device Specification (Qualcomm Technologies' 80-YA116-1)
- RB01 Development Platform Hardware User Guide (Qualcomm Technologies' 80-YA116-13)
- RB02 Hardware Release Notes (Qualcomm Technologies' 80-YA116-18)

2 Supported hardware

The RB01 is a development platform used with the following Wi-Fi modules:

- RB02 Based on the QCA4010 1x1 single-band Wi-Fi SoC. Supports 2.4 GHz operation.
- RB04 Based on the QCA4010 1x1 single-band Wi-Fi SoC. Supports 2.4 GHz, and CSR8811 BT v4.0 IC.

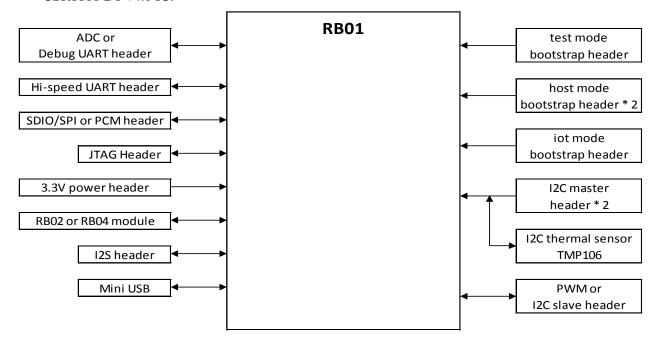


Figure 1 RB01 connection diagram

RB01 Hardware Release Notes

3 RB01 change history

Table 1 RB01 module revisions

Revision	Module no.	Change
CUS510-010	20-YA040-H1	-
RB01-010	20-YA162-H1	Added JTAG HEADER JP12Changed J4.2 Pin to +3.3VB Net